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PATENT NUMBER and  
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10075465	02/15/2002	438	149	2922 2011	GEYER

\*\*APPLICANTS: Oyamatsu Hisato;

\*\*CONTINUING DATA VERIFIED:

\*\* FOREIGN APPLICATIONS VERIFIED:

JAPAN 2001-392571 12/25/2001

PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO
35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		219660US2S
Verified and Acknowledged Examiners's initials		
TITLE : Semiconductor device having patterned SOI structure and method for fabricating the same		

U.S. DEPT. OF COMM/PAT. & TM-PTO-436L (Rev. 12-94)

<b>NOTICE OF ALLOWANCE MAILED</b>		<b>CLAIMS ALLOWED</b>	
		Total Claims	Print Claim for O.G.
Assistant Examiner		<b>DRAWING</b>	
<b>ISSUE FEE</b>		Sheets Drwg.	Figs. Drwg.
Amount Due	Date Paid	Print Fig.	
		Application Examiner	
<input type="checkbox"/> <b>TERMINAL DISCLAIMER</b>		<b>PREPARED FOR ISSUE</b>	
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